



FOD050L, FOD053L LVTTL/LVCMOS 3.3 V High Speed Transistor Optocouplers

Features

- Low Power Consumption
- High Speed
- Available in Single-channel 8-pin SOIC (FOD050L) or Dual-channel 8-pin SOIC (FOD053L)
- Superior CMR CM_H = 50kV/µs (typical) and $CM_L = 35kV/\mu s$ (typical)
- Guaranteed performance over temperature: 0°C to 70°C
- Safety and Regulatory Approvals:
 - UL1577, 2,500 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 565 V Peak Working Insulation Voltage

Applications

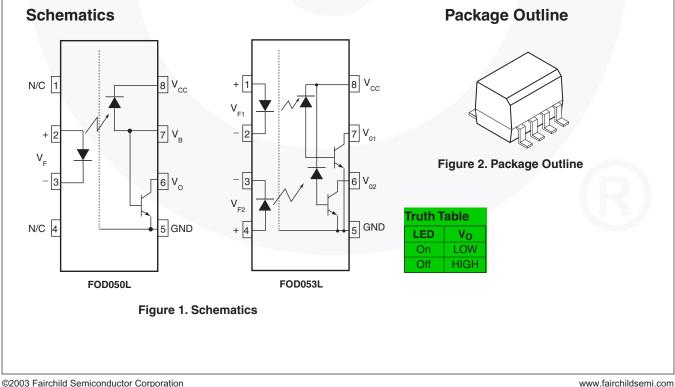
- Line Receivers
- Pulse Transformer Replacement
- High-speed Logic Ground Isolation: LVTTL/LVCMOS
- Wide Bandwidth Analog Coupling

Description

The FOD050L and FOD053L optocouplers consist of an AIGaAs LED optically coupled to a high speed photodetector transistor. These devices are specified for operation at a 3.3 V supply voltage.

A separate connection for the bias of the photodiode improves the speed by several orders of magnitude over conventional phototransistor optocouplers by reducing the base-collector capacitance of the input transistor.

An internal noise shield provides superior common mode rejection of $CM_{H} = 50 \text{ kV/}\mu\text{s}$ (typical) and $CM_L = 35 \text{ kV/}\mu \text{s}$ (typical).



Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter	Characteristics	
Installation Classifications per DIN VDE	< 150 V _{RMS}	I–IV
0110/1.89 Table 1, For Rated Mains Voltage	< 300 V _{RMS}	I–III
Climatic Classification		55/100/21
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter		Value	Unit
M	Input-to-Output Test Voltage, Method A, $V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test with t _m = 10 s, Partial Discharge < 5 pC		904	V _{peak}
V_{PR} Input-to-Output Test Voltage, Method B, $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1$ s, Partial Discharge < 5 pC		1060	V _{peak}	
V _{IORM}	Maximum Working Insulation Voltage		565	V _{peak}
V _{IOTM}	Highest Allowable Over-Voltage		4000	V _{peak}
	External Creepage		≥ 4	mm
	External Clearance		≥ 4	mm
DTI	Distance Through Insulation (Insulation Thic	kness)	≥ 0.4	mm
Τ _S	Case Temperature ⁽¹⁾		150	°C
I _{S,INPUT}	Input Current ⁽¹⁾		200	mA
P _{S,OUTPUT}	Output Power ⁽¹⁾		300	mW
R _{IO}	Insulation Resistance at T_S , V_{IO} = 500 $V^{(1)}$		> 10 ⁹	Ω

Note:

1. Safety limit values - maximum values allowed in the event of a failure.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. $T_A = 25^{\circ}C$ unless otherwise specified.

Symbol	Paramete	er	Value	Unit
T _{STG}	Storage Temperature		-40 to +125	°C
T _{OPR}	Operating Temperature		-40 to +85	°C
Τ _J	Junction Temperature		-40 to +125	°C
T _{SOL}	Lead Solder Temperature		260 for 10 seconds	°C
EMITTER				
I _F (avg)	DC/Average Forward Input Current	Each Channel	25	mA
I _F (pk)	Peak Forward Input Current (50% duty cycle, 1 ms P.W.)	Each Channel	50	mA
I _F (trans)	Peak Transient Input Current (≤1 µs P.W., 300 pps)	Each Channel	1.0	A
V _R	Reverse Input Voltage	Each Channel	5	V
P _D	Input Power Dissipation (No derating required up to 85°C)	Each Channel	45	mW
DETECTOR	ł			
I _O (avg)	Average Output Current	Each Channel	8	mA
l _O (pk)	Peak Output Current	Each Channel	16	mA
V _{EBR}	Emitter-Base Reverse Voltage	FOD050L only	5	V
V _{CC}	Supply Voltage		-0.5 to 7	V
V _O	Output Voltage		-0.5 to 7	V
Ι _Β	Base Current	FOD050L only	5	mA
P _D	Output Power Dissipation (No derating required up to 85°C)	Each Channel	100	mW

Electrical Characteristics

 $T_A = 0$ to 70°C unless otherwise specified.

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
EMITTER	EMITTER						
)/ Input Forward)/altage		I _F = 16 mA, T _A = 25°C	All		1.45	1.7	V
V _F	Input Forward Voltage	I _F = 16 mA				1.8	v
B _{VR}	Input Reverse Breakdown Voltage	I _R = 10 μA	All	5.0			V
DETECTOR							
I _{OH}	Logic High Output Current	$I_F = 0 \text{ mA}, V_O = V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$	All		0.001	1	μA
1	Logic Low Supply	$I_F = 16 \text{ mA}, V_O = \text{Open}, V_{CC} = 3.3 \text{ V}$	FOD050L			200	
ICCL	Current	$I_{F1} = I_{F2} = 16 \text{ mA},$ $V_O = \text{Open}, V_{CC} = 3.3 \text{ V}$	FOD053L			400	μA
Logic High Supply		$I_{F} = 0 \text{ mA}, V_{O} = \text{Open}, \\ V_{CC} = 3.3 \text{ V}, T_{A} = 25^{\circ}\text{C}$	FOD050L			0.3	
Іссн	Current	$I_{F} = 0 \text{ mA}, V_{O} = \text{Open}, \\ V_{CC} = 3.3 \text{ V}$	FOD053L			10	μA

Transfer Characteristics

Symbol	Parameter	Test Conditions	Device	Min.	Тур.	Max.	Unit
COUPLED							
CTR	Current Transfer Ratio ⁽²⁾	$I_F = 16 \text{ mA}, V_O = 0.4 \text{ V},$ $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$	All	15		50	%
V _{OL}	Logic Low Output Voltage Output Voltage	$I_F = 16 \text{ mA}, I_O = 3 \text{ mA},$ $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$	All			0.3	V

Note:

2. Current Transfer Ratio is defined as a ratio of output collector current, I_O, to the forward LED input current, I_F, times 100%.

Electrical Characteristics (Continued)

 $T_A = 0$ to 70°C unless otherwise specified.

Switching Characteristics (V_{CC} = 3.3 V)

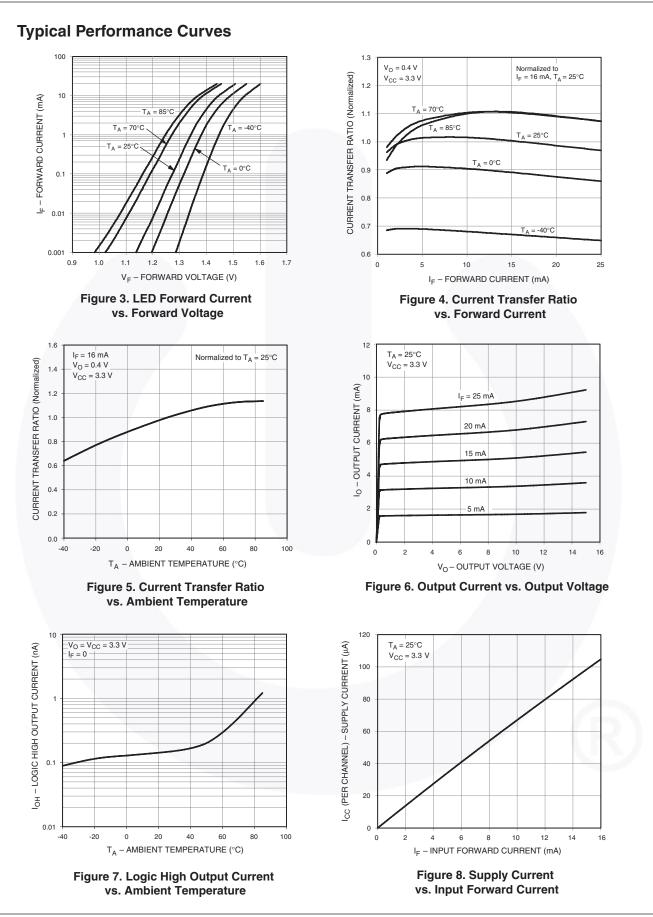
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
т	Propagation Delay	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}^{(3)}$	25°C			1.0	
T _{PHL}	Time to Logic LOW	(Figure 11)				2.0	μs
T _{PLH}	Propagation Delay	$R_L = 1.9 \text{ k}\Omega, I_F = 16 \text{ mA}^{(3)}$	25°C			1.0	116
	Time to Logic HIGH	(Figure 11)				2.0	μs
ICMHI	Common Mode Transient Immunity	$I_{F} = 0 \text{ mA, } V_{CM} = 1,000 \text{ V}_{P\text{-}P}, \text{ R}_{L} = 4.1 \text{ k}$ $T_{A} = 25^{\circ}\text{C}^{(4)(5)} \text{ (Figure 12)}$	Ω,	5,000	50,000		V/µs
10IMHI	at Logic HIGH	$I_F = 0 \text{ mA}, V_{CM} = 1,000 \text{ V}_{P-P}, T_A = 25^{\circ}\text{C},$ $R_L = 1.9 \text{ k}\Omega^{(3)(5)}$ (Figure 12)		5,000	50,000		V/µs
	Common Mode	$\begin{split} I_{F} &= 16 \text{mA}, \text{V}_{CM} = 1,000 \text{V}_{\text{P-P}}, \text{R}_{\text{L}} = 4.1 \text{ k} \\ T_{\text{A}} &= 25^{\circ}\text{C}^{(4)(5)} \text{ (Figure 12)} \end{split}$	άΩ,	5,000	35,000		V/µs
ICMLI	Transient Immunity at Logic LOW	$I_F = 16 \text{ mA}, V_{CM} = 1,000 \text{ V}_{P-P}, \text{ R}_L = 1.9 \text{ I}$ (Figure 12)	kΩ ⁽³⁾⁽⁵⁾	5,000	35,000		V/µs

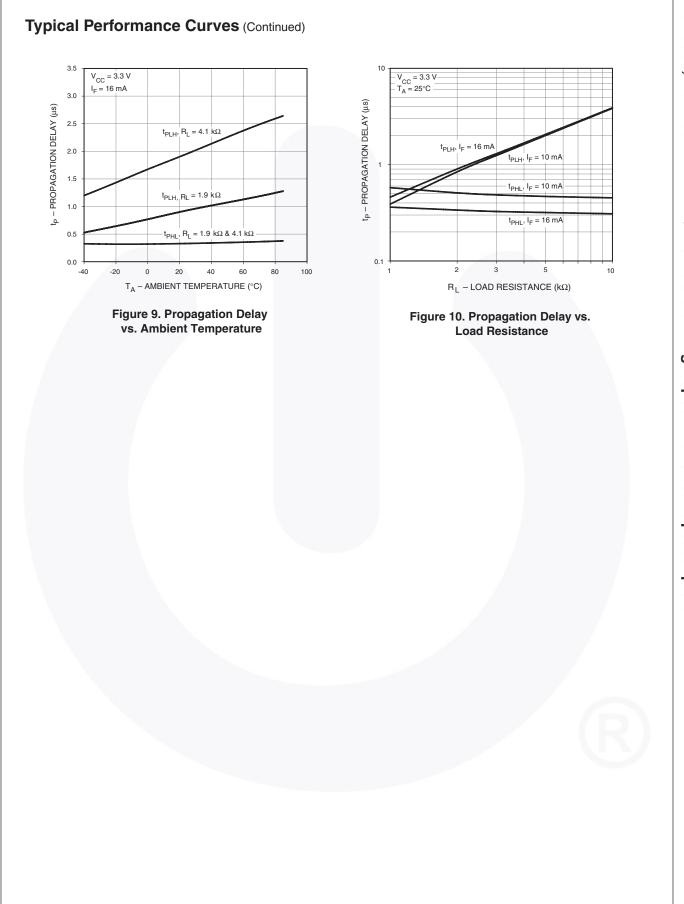
Isolation Characteristics

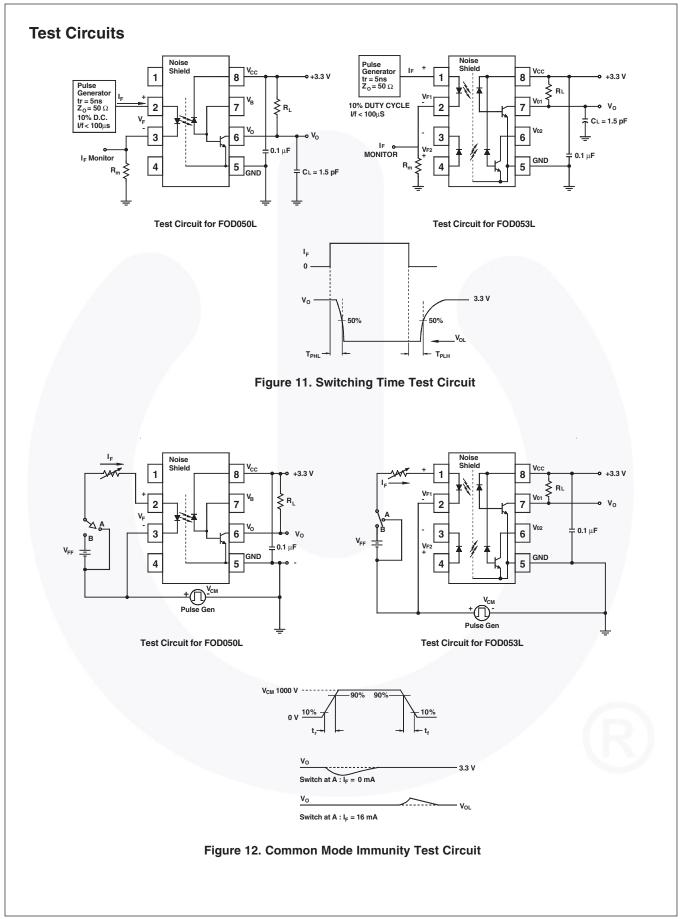
Symbol	Characteristics	Test Conditions	Min.	Тур.	Max.	Unit
I _{I-O}	Input-Output Insulation Leakage Current	$\label{eq:relative humidity} \begin{split} \text{Relative humidity} &= 45\%, \ \text{T}_{\text{A}} = 25^{\circ}\text{C}, \\ \text{t} &= 5 \text{ s}, \ \text{V}_{\text{I-O}} = 3000 \ \text{VDC}^{(6)} \end{split}$			1.0	μA
V _{ISO}	Withstand Insulation Test Voltage	f = 60Hz, $T_A = 25^{\circ}C$, t = 60 s ⁽⁶⁾	2500			V _{RMS}
R _{I-O}	Resistance (Input to Output)	$V_{I-O} = 500 \text{ VDC}^{(6)}$	10 ¹¹	10 ¹²		Ω
C _{I-O}	Capacitance (Input to Output)	$f = 1 \text{ MHz}^{(6)}$		0.2		pF

Notes:

- 3. The 1.9 k\Omega load represents 1 TTL unit load of 1.6 mA and 5.6 k\Omega pull-up resistor.
- 4. The 4.1 k Ω load represents 1 LSTTL unit load of 0.36 mA and 6.1 k Ω pull-up resistor.
- 5. Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm} / dt on the leading edge of the common mode pulse signal V_{CM} , to assure that the output will remain in a logic high state (i.e., $V_O > 2.0$ V). Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm} / dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a logic low state (i.e., $V_O < 0.8$ V).
- 6. Device is considered a two terminal device: pins 1, 2, 3 and 4 are shorted together and pins 5, 6, 7 and 8 are shorted together.







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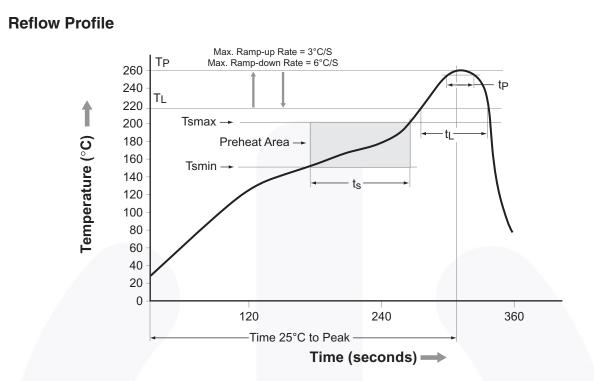


	Figure	13.	Reflow	Profile
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Profile Freature	Pb-Free Assembly Profile		
Temperature Minimum (Tsmin)	150°C		
Temperature Maximum (Tsmax)	200°C		
Time (t _S) from (Tsmin to Tsmax)	60–120 seconds		
Ramp-up Rate (t _L to t _P)	3°C/second maximum		
Liquidous Temperature (T _L)	217°C		
Time (t_L) Maintained Above (T_L)	60–150 seconds		
Peak Body Package Temperature	260°C +0°C / -5°C		
Time (t _P) within 5°C of 260°C	30 seconds		
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second maximum		
Time 25°C to Peak Temperature	8 minutes maximum		

Ordering Information

Part Number	Package	Packing Method
FOD050L	Small Outline 8-Pin	Tube (100 Units)
FOD050LR2	Small Outline 8-Pin	Tape and Reel (1000 Units)
FOD050LV	Small Outline 8-Pin, DIN EN/IEC60747-5-5 Option	Tube (100 Units)
FOD050LR2V	Small Outline 8-Pin, DIN EN/IEC60747-5-5 Option	Tape and Reel (1000 Units)

Note:

7. The product orderable part number system listed in this table also applies to the FOD053L product.

Marking Information

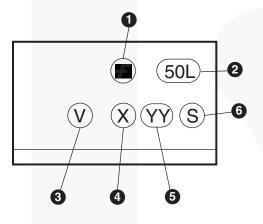
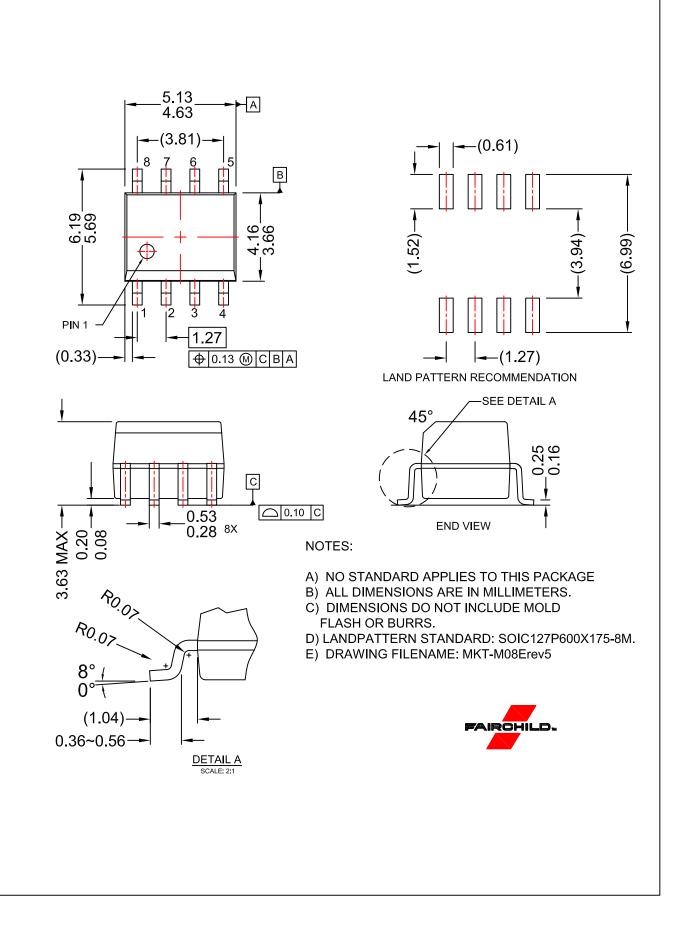
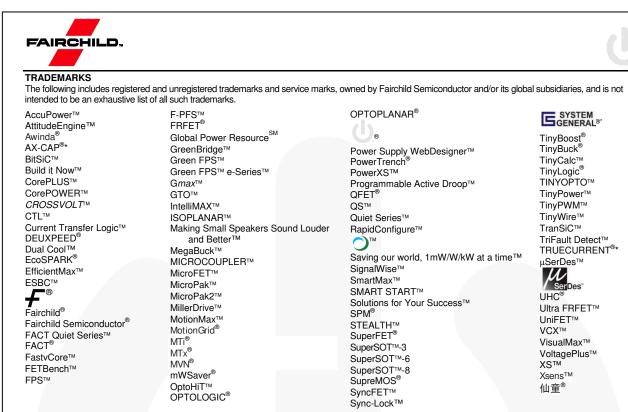


Figure 14. Top Mark

Table 1. Top Mark Definitions

1	Fairchild Logo	
2	Device Number	
3	3 DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)	
4	4 One-Digit Year Code, e.g., "5"	
5	Digit Work Week, Ranging from "01" to "53"	
6	Assembly Package Code	





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Datasheet Identification	Product Status	Definition
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